

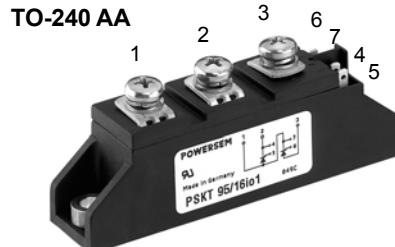
Thyristor Modules Thyristor/Diode Modules

PSKT 56
PSKH 56

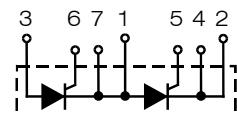
I_{TRMS} = 2 x 100 A
 I_{TAVM} = 2 x 64 A
 V_{RRM} = 800-1800 V

Preliminary Data Sheet

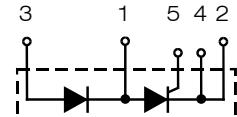
V_{RSM} V_{DSM}	V_{RRM} V_{DRM}	Type		
V	V	Version 1	Version 8	
900	800	PSKT 56/08io1	PSKT 56/08io8	PSKH 56/08io8
1300	1200	PSKT 56/12io1	PSKT 56/12io8	PSKH 56/12io8
1500	1400	PSKT 56/14io1	--	PSKH 56/14io8
1700	1600	PSKT 56/16io1	PSKT 56/16io8	PSKH 56/16io8
1900	1800	PSKT 56/18io1	--	PSKH 56/18io8



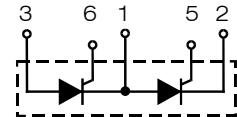
**PSKT
Version 1**



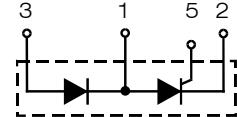
**PSKH
Version 1**



**PSKT
Version 8**



**PSKH
Version 8**



Symbol	Test Conditions	Maximum Ratings		
I_{TRMS}, I_{FRMS}	$T_{VJ} = T_{VJM}$	100	A	
I_{TAVM}, I_{FAVM}	$T_c = 83^\circ\text{C}$; 180° sine	64	A	
	$T_c = 85^\circ\text{C}$; 180° sine	60	A	
I_{TSM}, I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $V_R = 0$	1500	A	
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	1600	A	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	1350	A	
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	1450	A	
$\int i^2 dt$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$	11 200	A^2s	
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	10 750	A^2s	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	9100	A^2s	
	$t = 10 \text{ ms (50 Hz), sine}$ $t = 8.3 \text{ ms (60 Hz), sine}$	8830	A^2s	
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$ $f = 50 \text{ Hz}, t_p = 200 \mu\text{s}$	repetitive, $I_T = 150 \text{ A}$	150	$\text{A}/\mu\text{s}$
	$V_D = 2/3 V_{DRM}$			
	$I_G = 0.45 \text{ A}$	non repetitive, $I_T = I_{TAVM}$	500	$\text{A}/\mu\text{s}$
	$di_G/dt = 0.45 \text{ A}/\mu\text{s}$			
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM};$ $R_{GK} = \infty$; method 1 (linear voltage rise)	$V_{DR} = 2/3 V_{DRM}$	1000	$\text{V}/\mu\text{s}$
P_{GM}	$T_{VJ} = T_{VJM}$	$t_p = 30 \mu\text{s}$	10	W
	$I_T = I_{TAVM}$	$t_p = 300 \mu\text{s}$	5	W
P_{GAV}			0.5	W
V_{RGM}			10	V
T_{VJ}			-40...+125	$^\circ\text{C}$
T_{VJM}			125	$^\circ\text{C}$
T_{stg}			-40...+125	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS	$t = 1 \text{ min}$	3000	V~
	$I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ s}$	3600	V~
M_d	Mounting torque (M5) Terminal connection torque (M5)		2.5-4.0/22-35 Nm/lb.in.	
Weight	Typical including screws		90	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

Features

- International standard package, JEDEC TO-240 AA
- Direct copper bonded Al_2O_3 -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered, E 148688
- Gate-cathode twin pins for version 1

Applications

- DC motor control
- Softstart AC motor controller
- Light, heat and temperature control

Advantages

- Space and weight savings
- Simple mounting with two screws
- Improved temperature and power cycling capability
- Reduced protection circuits

Symbol	Test Conditions	Characteristic Values		
I_{RRM}, I_{DRM}	$T_{VJ} = T_{VJM}; V_R = V_{RRM}; V_D = V_{DRM}$	5	mA	
V_T, V_F	$I_T, I_F = 200 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.57	V	
V_{T0}	For power-loss calculations only ($T_{VJ} = 125^\circ\text{C}$)	0.85	V	
r_T		3.7	$\text{m}\Omega$	
V_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	1.5	V	
I_{GT}	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	100	mA	
I_{GD}	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	0.2	V	
I_{GD}		10	mA	
I_L	$T_{VJ} = 25^\circ\text{C}; t_p = 10 \mu\text{s}; V_D = 6 \text{ V}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	450	mA	
I_H	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	200	mA	
t_{gd}	$T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	2	μs	
t_q	$T_{VJ} = T_{VJM}; I_T = 150 \text{ A}, t_p = 200 \mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s}$ $V_R = 100 \text{ V}; dv/dt = 20 \text{ V}/\mu\text{s}; V_D = 2/3 V_{DRM}$	typ.	150	μs
Q_s	$T_{VJ} = T_{VJM}; I_T, I_F = 50 \text{ A}, -di/dt = 3 \text{ A}/\mu\text{s}$	100	μC	
I_{RM}		24	A	
R_{thJC}	per thyristor/diode; DC current	0.45	K/W	
R_{thJK}	per module per thyristor/diode; DC current	0.225	K/W	
	other values see Fig. 8/9	0.65	K/W	
		0.325	K/W	
d_s	Creepage distance on surface	12.7	mm	
d_A	Strike distance through air	9.6	mm	
a	Maximum allowable acceleration	50	m/s^2	

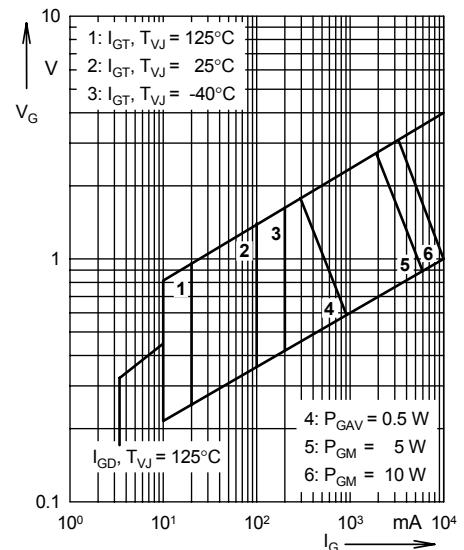


Fig. 1 Gate trigger characteristics

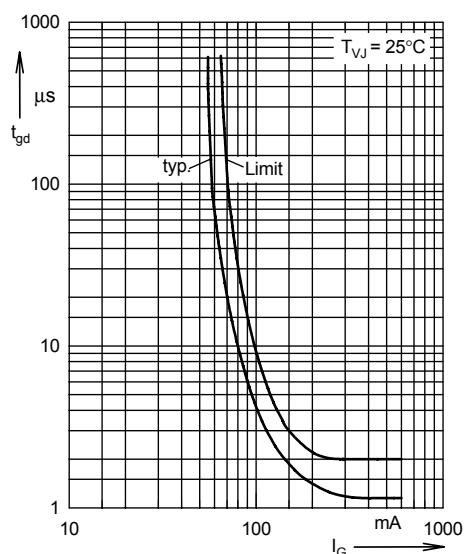
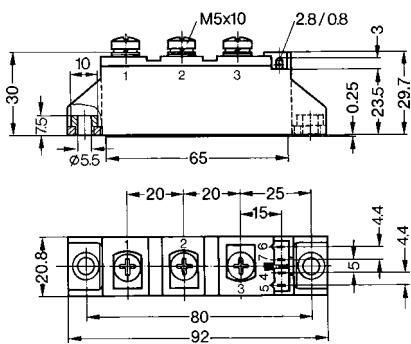


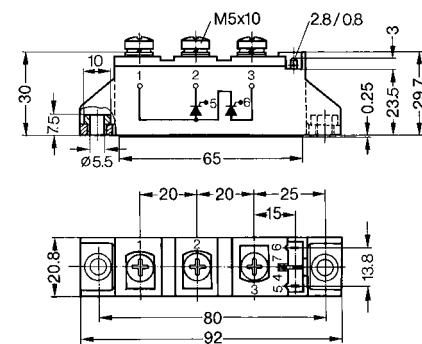
Fig. 2 Gate trigger delay time

Dimensions in mm (1 mm = 0.0394")

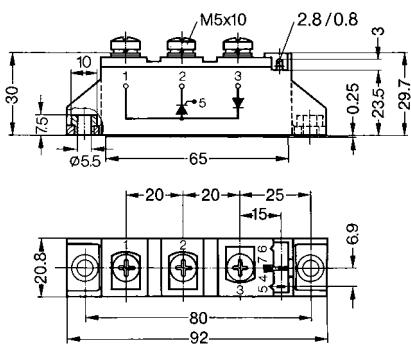
PSKT/PSKH Version 1



PSKT Version 8



PSKH Version 8



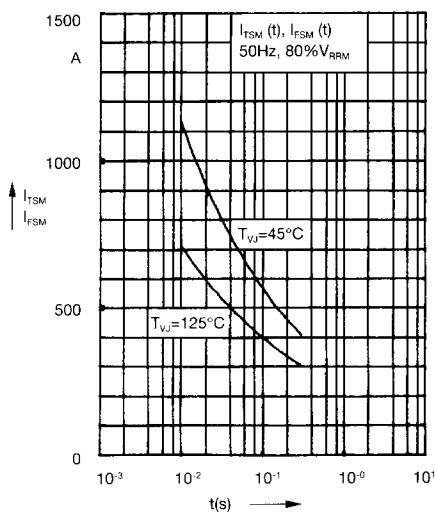


Fig. 3 Surge overload current
 I_{TSM}, I_{FSM} : Crest value, t : duration

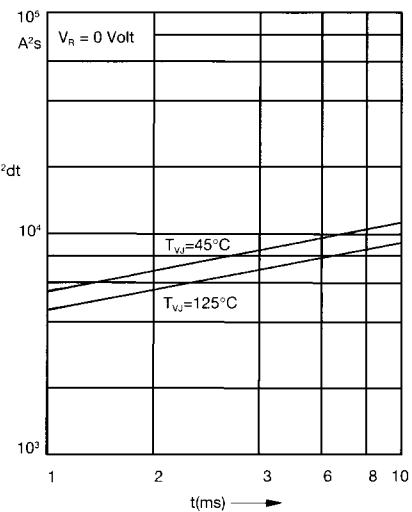


Fig. 4 $\int j^2 dt$ versus time (1-10 ms)

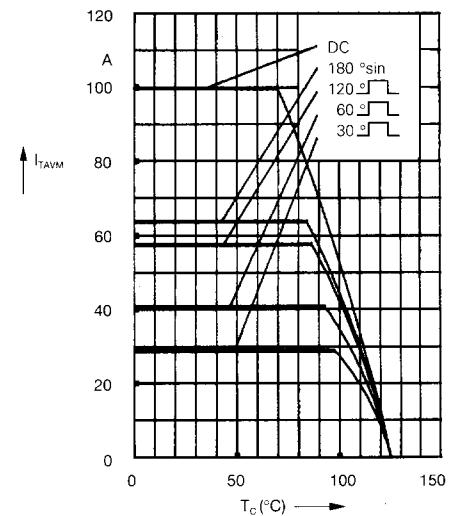


Fig. 4a Maximum forward current at case temperature

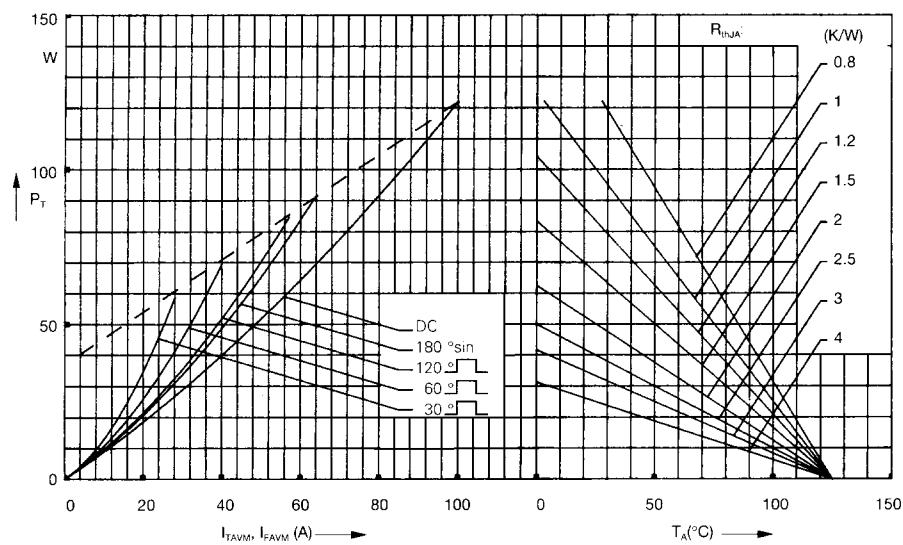


Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

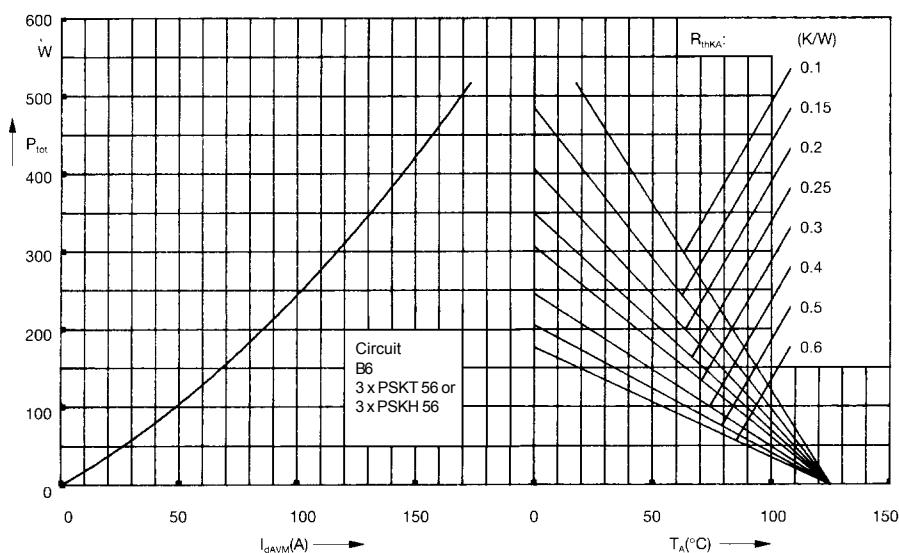


Fig. 6 Three phase rectifier bridge:
Power dissipation versus direct output current and ambient temperature

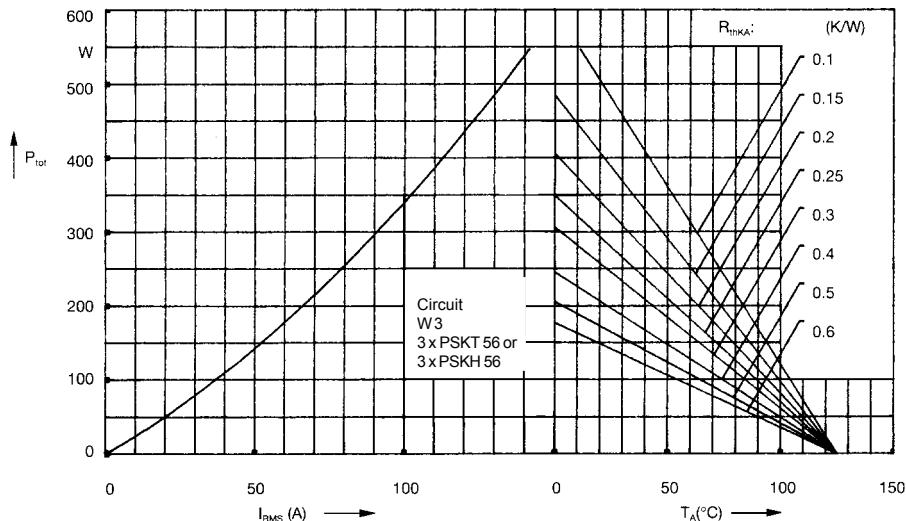


Fig. 7 Three phase AC-controller:
Power dissipation versus RMS
output current and ambient
temperature

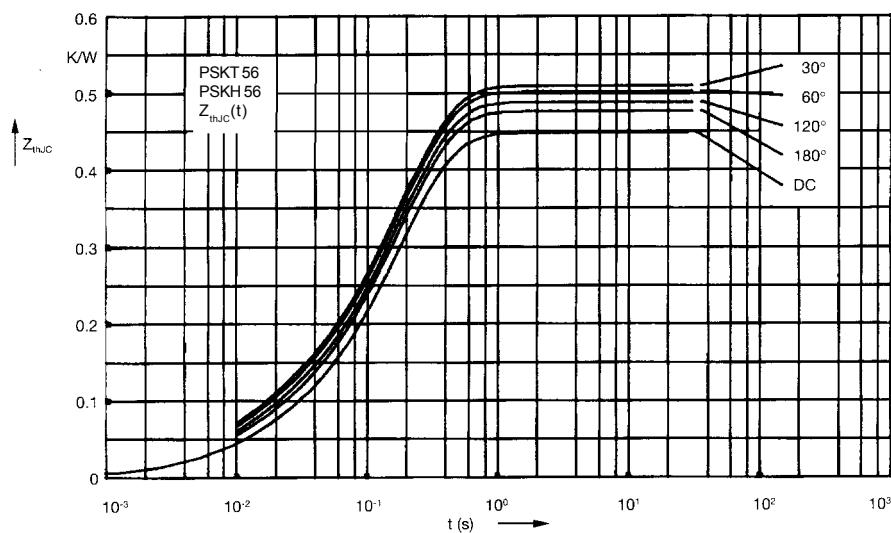


Fig. 8 Transient thermal impedance
junction to case (per thyristor or
diode)

R_{thJC} for various conduction angles d:

d	R_{thJC} (K/W)
DC	0.45
180°	0.47
120°	0.49
60°	0.505
30°	0.52

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.014	0.015
2	0.026	0.0095
3	0.41	0.175

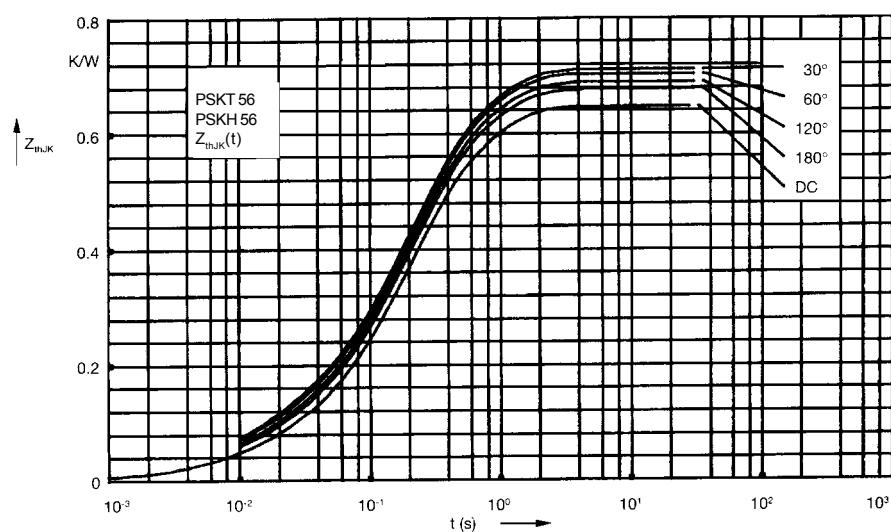


Fig. 9 Transient thermal impedance
junction to heatsink (per thyristor or
diode)

R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.65
180°	0.67
120°	0.69
60°	0.705
30°	0.72

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.014	0.015
2	0.026	0.0095
3	0.41	0.175
4	0.2	0.67